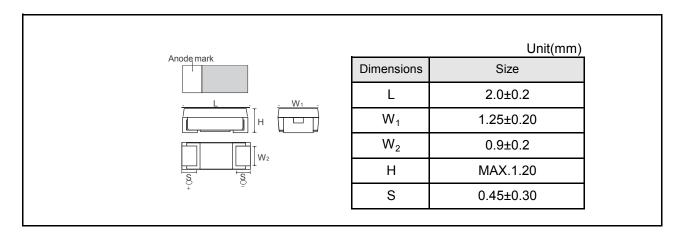
Chip tantalum capacitors

TC series P case Datasheet

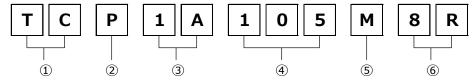
Features

- 1) Small package, large capacitance chip tantalum capacitor.
- 2) Low impedance capacitors.
- 3) Screening by thermal shock.

Dimensions



Part No. Explanation



① Series name TC

② Case code

P: 2012-12(0805)size

3 Rated voltage

| rated voltage | | | | | | |
|---------------|------------------|--|--|--|--|--|
| Code | Rated voltage(V) | | | | | |
| 0E | 2.5 | | | | | |
| 0G | 4 | | | | | |
| 0J | 6.3 | | | | | |
| 1A | 10 | | | | | |
| 1B | 13 | | | | | |
| 1C | 16 | | | | | |
| 1D | 20 | | | | | |
| 1E | 25 | | | | | |
| 1V | 35 | | | | | |

4 Nominal capacitance

Nominal capacitance in pF in 3 digits: 2 significant figures followed by the figure representing the number of 0's.

⑤ Capacitance tolerance

M: ±20%

6 Taping

8: Real width: 8mm

R: Positive electrode on the side opposite to sprocket hole

Rated table

| Capacitance | Rated voltage(V.DC) | | | | | | | |
|-------------|---------------------|-----|----|----|----|----|----|--|
| (µF) | 4 | 6.3 | 10 | 16 | 20 | 25 | 35 | |
| 1.0 (105) | | | Р | Р | | Р | | |
| 2.2 (225) | | Р | Р | | | | | |
| 3.3 (335) | | | | | | | | |
| 4.7 (475) | | Р | Р | | | | | |
| 10 (106) | Р | Р | Р | | | | | |
| 15 (156) | | | | | | | | |
| 22 (226) | Р | Р | | | | | | |
| 33 (336) | | | | | | | | |
| 47 (476) | | | | | | | | |
| 100 (107) | | | | | | | | |

Remark) Case size codes (P) in the above show products line-up.

Marking

The indications listed below should be given on the surface of a capacitor.

(1) Polarity : The polarity should be shown by \square bar. (on the anode side)

(2) Rated DC voltage: A voltage code is shown as below table.

(3) Capacitance : A capacitance code is shown as below table.

| Voltage | Rated DC |
|---------|-------------|
| Code | Voltage (V) |
| е | 2.5 |
| g | 4 |
| j | 6.3 |
| Α | 10 |
| С | 16 |
| D | 20 |
| E | 25 |
| V | 35 |

| Capacitance | Nominal | Capacitance | Nominal |
|-------------|------------------|-------------|------------------|
| Code | Capacitance (µF) | Code | Capacitance (µF) |
| <u>N</u> | 0.33 | е | 15 |
| <u>S</u> | 0.47 | j | 22 |
| Α | 1.0 | n | 33 |
| E | 1.5 | s | 47 |
| J | 2.2 | а | 100 |
| N | 3.3 | е | 150 |
| S | 4.7 | ij | 220 |
| а | 10 | n | 330 |

Visual typical example

voltage code and capacitance code are variable with parts number.

[TC series P case]

- (1) voltage code
- (2) capacitance code



manufacture code

Characteristics

| Iten | 1 | Performance | Test condition (Based on JIS C 5101-1, JIS C 5101-3) | | | | |
|---------------------|------------|--|---|--|--|--|--|
| Operating temperat | ure | -55℃~+125℃ | Voltage reduction when temperature exceeds | | | | |
| | | | +85°C | | | | |
| Maximum operating | J | +85°C | | | | | |
| temperature with no |) | | | | | | |
| voltage derating. | | | | | | | |
| Rated voltage(V.DC | () | Refer to " Standard list ". | at 85℃ | | | | |
| Category voltage(V | .DC) | Refer to " Standard list ". | at 125°C | | | | |
| Surge voltage(V.D0 | C) | Refer to " Standard list ". | at 85℃ | | | | |
| DC leakage current | | Shall be satisfied the value on " Standard list ". | As per 4.9 JIS C 5101-1-1 | | | | |
| | | | As per 4.5.1 JIS C 5101-3 | | | | |
| | | | Voltage : Rated voltage for 1min. | | | | |
| Capacitance tolerar | nce | Shall be satisfied allowance range. | As per 4.7 JIS C 5101-1 | | | | |
| | | ±20% | As per 4.5.2 JIS C 5101-3 | | | | |
| | | | Measuring frequency : 120+12Hz | | | | |
| | | | Measuring voltage : 0.5Vrms+1.5V.DC | | | | |
| | | | Measuring circuit : DC equivalent series circuit | | | | |
| Tangent of loss and | ıle | Shall be satisfied the value on " Standard list ". | As per 4.8 JIS C 5101-1 | | | | |
| (Df,tanδ) | | | As per 4.5.3 JIS C 5101-3 | | | | |
| | | | Measuring frequency : 120+12Hz | | | | |
| | | | Measuring voltage : 0.5Vrms+1.5V.DC | | | | |
| | | | Measuring circuit : DC equivalent series circuit | | | | |
| Impedance | | Shall be satisfied the value on " Standard list ". | As per 4.10 JIS C 5101-1 As per 4.5.4 JIS C 5101-3 | | | | |
| | | | | | | | |
| | | | Measuring frequency : 120+12Hz Measuring voltage : 0.5Vrms+1.5V.DC | | | | |
| | | | Measuring circuit : DC equivalent series circuit | | | | |
| Resistance | App- | There should be no significant abnormality. | As per 4.14 JIS C 5101-1 | | | | |
| to soldering | arance | The indications should be clear. | As per 4.6 JIS C 5101-3 | | | | |
| heat | L.C. | Less than 200% of initial limit. | Dip in the solder bath. | | | | |
| | | | Solder temp. : 260±10°C | | | | |
| | ⊿C/C | Within ±20% of initial limit. | Duration : 5±0.5s | | | | |
| | | | Repetition : 1 | | | | |
| | DF | Less than 200% of initial limit. | After the specimens, leave it at room temperature | | | | |
| | (tanδ) | | for over 24h and then measure the sample. | | | | |
| Temperature | App- | There should be no significant abnormality. | As per 4.16 JIS C 5101-1 | | | | |
| cycle | arance | The indications should be clear. | As per 4.10 JIS C 5101-3 | | | | |
| | L.C. | Less than 200% of initial limit. | Repetition : 5cycles | | | | |
| | | | (1cycle:steps1~4)Without discontinuation | | | | |
| | ⊿C/C | Within ±20% of initial limit. | | | | | |
| | _ | | Temp. Time | | | | |
| | DF | Less than 200% of initial limit. | 1 -55°C±3°C 30±3min | | | | |
| | (tanδ) | | 2 Room temp. 3min or less | | | | |
| | | | 3 125±2°C 30±3min | | | | |
| | | | 4 Room temp. 3min or less | | | | |
| | | | After the specimens, leave it at room temperature | | | | |



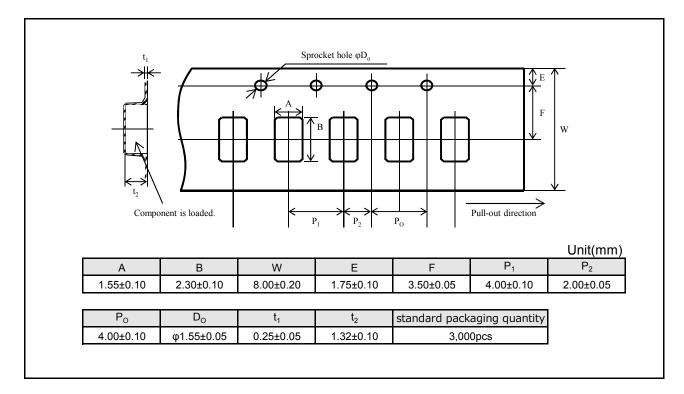
| Item | | Performance | Test condition (Based on JIS C 5101-1, JIS C 5101-3) | | | |
|---------------|-------------|--|---|--|--|--|
| Moisture | App- | There should be no significant abnormality. | As per 4.22 JIS C 5101-1 | | | |
| resistance | arance | The indications should be clear. | As per 4.12 JIS C 5101-3 | | | |
| resistance | L.C. | Less than 200% of initial limit. | After leaving the sample under such atmospheric | | | |
| | L.C. | Less than 200% of initial limit. | | | | |
| | 40/0 | William 2007 of the Health of | condition that the temperature and humidity are | | | |
| | ⊿C/C | Within ±20% of initial limit. | 60±2°C and 90~95%(Relative Humidity), | | | |
| | | | respectively ,for 500±24h leave it at room | | | |
| | DF | Less than 200% of initial limit. | temperature for over 24h and then measure the | | | |
| | (tanδ) | | sample. | | | |
| Temperature | Temp : -55° | T | As per 4.29 JIS C 5101-1 | | | |
| | ⊿C/C | Within 0/-15% of initial limit. | As per 4.13 JIS C 5101-3 | | | |
| | tanō | Shall be satisfied the value on " Standard list ". | | | | |
| | L.C. | - | | | | |
| | Temp: +85° | Т | | | | |
| | ⊿C/C | Within +15/0% of initial limit. | | | | |
| | tanō | Shall be satisfied the value on " Standard list ". | | | | |
| | L.C. | Less than 1000% of initial limit. | | | | |
| | Temp : +125 | | - | | | |
| | ⊿C/C | Within +20/0% of initial limit. | | | | |
| | tanō | Shall be satisfied the value on " Standard list ". | | | | |
| | L.C. | Less than 1250% of initial limit. | | | | |
| Surge voltage | App- | There should be no significant abnormality. | As per 4.26 JIS C 5101-1 | | | |
| | arance | The indications should be clear. | As per 4.14 JIS C 5101-3 | | | |
| | L.C. | Less than 200% of initial limit. | Apply the specified serge voltage via the serial resistance of 1kΩ ever 5±0.5min for 30±5s each | | | |
| | ⊿C/C | Within ±20% of initial limit. | time in the atmospheric condition of 85±2°C. Repeat this procedure 1,000 times. After the | | | |
| | DF | Less than 200% of initial limit. | specimens, leave it at room temperature for over | | | |
| | (tanδ) | | 24h and then measure the sample. | | | |
| Loading at | App- | There should be no significant abnormality. | As per 4.23 JIS C 5101-1 | | | |
| high | arance | The indications should be clear. | As per 4.15 JIS C 5101-3 | | | |
| temperature | L.C. | Less than 200% of initial limit. | After applying the rated voltage for 1000+72/0h | | | |
| temperature | 2.0. | Less train 200 /0 Of Hillidi IIIIIIt. | without discontinuation via the serial resistance | | | |
| _ | | Within ±20% of initial limit. | | | | |
| | 1C/C | | | | | |
| | ⊿c/c | Within £20 % of linear line. | of 3Ω or less at a temperature of $85\pm2^{\circ}$ C, leave | | | |
| | ⊿C/C DF | Less than 200% of initial limit. | the sample at room temperature/humidity for over 24h and measure the value. | | | |

| Item | | Performance | ,_ | Test condition | | |
|---------------------|---------|---|-------------------|--|--|--|
| | | | | Based on JIS C 5101-1, JIS C 5101-3) | | |
| Terminal | Capa- | The measured value should be stable. | As per 4.35 JIS | | | |
| strength | citance | | As per 4.9 JIS 0 | | | |
| | App- | There should be no significant abnormality. | | d to the terminal until it bends | | |
| | arance | | to 1mm and by a | a prescribed tool maintains the | | |
| | | | | Unit(mm) | | |
| | | | | 50 / 20 | | |
| | | | | F(Apply force) | | |
| | | | | $\left \frac{\text{R230}}{}\right $ | | |
| | | | | 1.0mm | | |
| | | | thick | ness=1.6mm | | |
| | | | linex | iness 1.0mm | | |
| | | | | $\overline{\varphi} + \overline{\varphi}$ | | |
| | | | | \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\ | | |
| | | | | 45 45 | | |
| Adhesiveness | | The terminal should not come off. | As per 4.34 JIS | | | |
| | | | As per 4.8 JIS C | | | |
| | | | | N in the two directions shown | | |
| | | | _ | w for 10±1s after mounting the | | |
| | | | terminal on a cir | cuit board. | | |
| | | | | Products | | |
| | | | | | | |
| | | | | | | |
| | | | | Apply force | | |
| | | | | A circuit board | | |
| | | | <u> </u> | | | |
| Dimensions | | Refer to "External dimensions" | | a caliper of JIS B 7507 class 2 | | |
| | | | or higher grade. | | | |
| Resistance to solve | ents | The indication should be clear. | As per 4.32 JIS | | | |
| | | | As per 4.18 JIS | | | |
| | | | | pyl alcohol for 30±5s , | | |
| | | | at room tempera | | | |
| Solder ability | | 3/4 or more surface area of the solder | As per 4.15.2 JI | | | |
| | | coated terminal dipped in the soldering | As per 4.7 JIS C | | | |
| | | bath should be covered with the new | Dip speed | : 25±2.5mm/s | | |
| | | solder. | Pre-treatment | : Leave the sample on the boiling | | |
| | | | (accelerated agi | S, | | |
| | | | Solder temp | : 245±5℃ | | |
| | | | Duration | : 3±0.5s | | |
| | | | Solder | : M705 | | |
| | | | Flux | : Rosin 25% | | |
| | | | | IPA 75% | | |
| Vibration Capa- | | Measure value should not fluctuate | As per 4.17 JIS | | | |
| | citance | during the measurement. | Frequency | : 10~55~10Hz/min. | | |
| | App- | There should be no significant abnormality. | Amplitude | : 1.5mm | | |
| | arance | | Time | : 2h each in X,Y and Z directions. | | |
| | | | Mounting | : The terminal is soldered on a | | |
| | I | | ľ | print circuit board. | | |

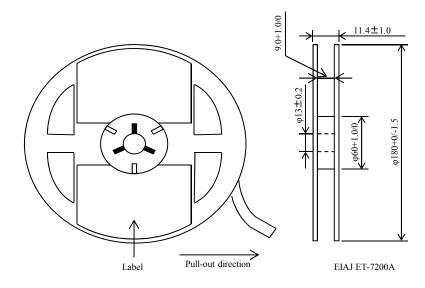
Standard products list

| | Rated | Category | Surge | Сар. | Tole- | Leakage | | tanδ | | Impedance |
|-------------|---------|----------|---------|-------|-------|---------|------|-------|------|-----------|
| | voltage | voltage | voltage | | rance | current | | | | |
| Dowt No. | 85℃ | 105℃ | 85℃ | 120Hz | | 25℃ | | 120Hz | | 100kHz |
| Part No | | | | | | 1WV | -55℃ | 25℃ | 125℃ | |
| | | | | | | 1min | | 85℃ | | |
| | (V) | (V) | (V) | (μF) | (%) | (µA) | (%) | (%) | (%) | (Ω) |
| TCP0G106M8R | 4 | 2.5 | 5 | 10 | ±20 | 0.5 | 30 | 20 | 30 | 9.3 |
| TCP0G226M8R | 4 | 2.5 | 5 | 22 | ±20 | 0.9 | 30 | 20 | 30 | 7.7 |
| TCP0J225M8R | 6.3 | 4 | 8 | 2.2 | ±20 | 0.5 | 30 | 20 | 30 | 17.5 |
| TCP0J475M8R | 6.3 | 4 | 8 | 4.7 | ±20 | 0.5 | 30 | 20 | 30 | 11.8 |
| TCP0J106M8R | 6.3 | 4 | 8 | 10 | ±20 | 0.6 | 30 | 20 | 30 | 8.3 |
| TCP0J226M8R | 6.3 | 4 | 8 | 22 | ±20 | 1.4 | 38 | 25 | 38 | 5.0 |
| TCP1A105M8R | 10 | 6.3 | 13 | 1.0 | ±20 | 0.5 | 15 | 10 | 15 | 17.5 |
| TCP1A225M8R | 10 | 6.3 | 13 | 2.2 | ±20 | 0.5 | 30 | 20 | 30 | 14.4 |
| TCP1A475M8R | 10 | 6.3 | 13 | 4.7 | ±20 | 0.5 | 30 | 20 | 30 | 9.3 |
| TCP1A106M8R | 10 | 6.3 | 13 | 10 | ±20 | 1.0 | 30 | 20 | 30 | 7.7 |
| TCP1C105M8R | 16 | 10 | 20 | 1.0 | ±20 | 0.5 | 15 | 10 | 15 | 16.1 |
| TCP1E105M8R | 25 | 16 | 32 | 1.0 | ±20 | 0.6 | 30 | 20 | 30 | 9.3 |

Packaging specifications



Reel dimensions



Notice

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| 1 / | | | | |
|-------|-----|----------|------------|----------|
| JAPA | N | USA | EU | CHINA |
| CLASS | эш | CLASSIII | CLASS II b | CLASSIII |
| CLASS | SIV | CLASSIII | CLASSⅢ | CLASSIII |

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Notice-PGA-E Rev.004

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TCSCS1A336KBAR TCTP0J336M8R B45196-H5106-K309 B45196-H6226-K509 CWR09JC225JBB T83D475K050RCCL
TCSCS1A476KBAR T83E107K016RCCL T83D685K035RCCL 595D107X0004B2T CWR11HH105KB 293D155X9020A2DE3
CWR09NC224KB CWR11MC685KCB CWR29FC685KCEC CWR09NC684KM CWR19MH106KCHB CWR29HH155KCBB
CWR29FC336KDGC CWR09NC225KDB CWR29FC475KDDC CWR29HC225KCAC CWR11KC106KBB CWR09JH105KC
293D476X9035E2TE3 CWR29JC335KDDC CWR29KC226JCGC CWR29FC105KDAC CWR29DC337KCHC NTC-T686K6.3TRBF
595D686X9010B2T 594D686X9016C2T 595D106X0025C8T TAZH685K035LBSB0824 TAZG107K010LBSB0800
TAZH475K050LBSB0H23 TAJD107K016KNJ TAZH227K010LBSB0024 TAZH156K025CBSZ0824 TAZH227J010LBSZ0800
TPSE687M006H0045 TBJD156K025CBSZ0824 TMCSA1V154MTRF TMCSA0G335MTRF